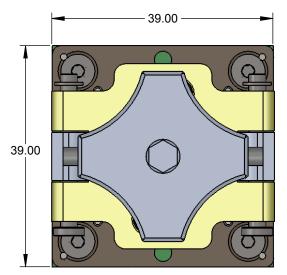
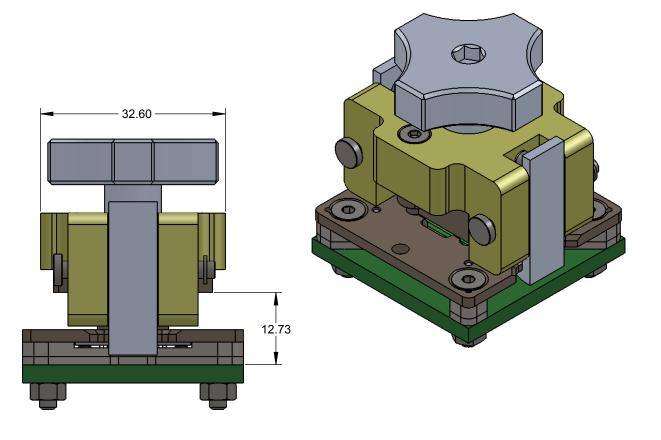
CBT-BGA DIRECT MOUNT, SOLDERLESS SOCKET FOR PRODUCTION APPLICATIONS



Features

- Wide temperature range (-55C to +180C).

- Wide temperature range (-55C to +180C).
 High current capability (up to 4A).
 Excellent signal integrity at high frequencies.
 Low and stable contact resistance for reliable production yield.
 Highly compliant to accommodate wide co-planarity variations.
 Automated probe manufacturing enables low cost and short lead time.



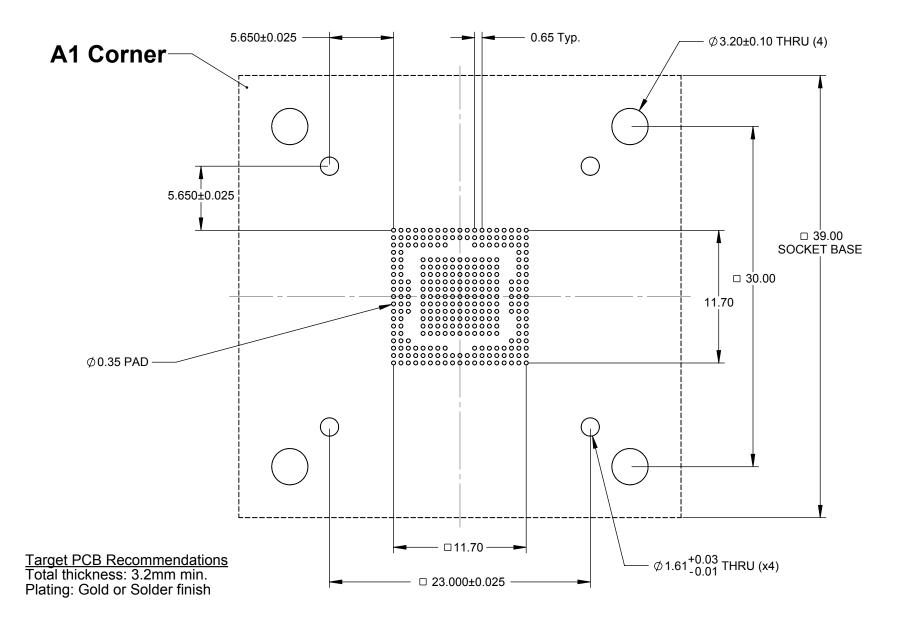
39.73 47.57 4.64

Description: CBT-BGA

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice

	CBT-BGA-7005 Drawing	Material: N/A	STATUS: Released	SHEET: 1 OF 5	REV. B
•	Ironwood Electronics, Inc. Tele: (800) 404-0204	Finish: N/A Weight: 82.83	ENG: M. Tully	DRAWN BY: M. Raske SCALE: 3:2	SCALE: 3:2
		Weight. 62.66	FILE: CBT-BGA-7005 Dwg DATE: 5/23/2014		



Description: CBT-BGA

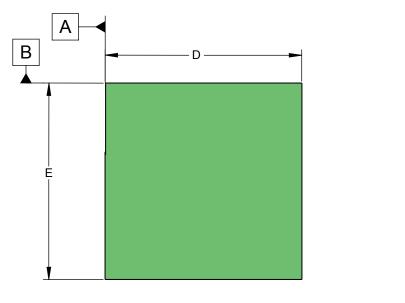
Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

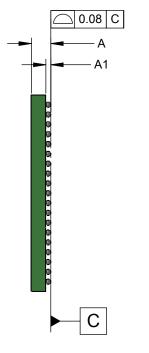
Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

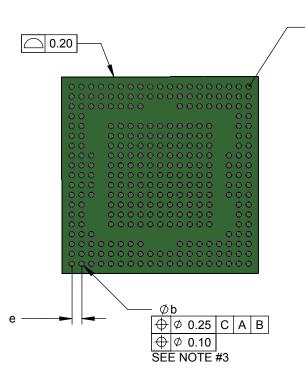
CBT-BGA-7005 Drawing Material: N/A STATUS: Released SHEET: 2 OF 5 REV. B Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Finish: N/A Weight: 82.83 ENG: M. Tully DRAWN BY: M. Raske SCALE: 3:1 FILE: CBT-BGA-7005 Dwg DATE: 5/23/2014

Ironwood Package Code: BGA293A

PIN 1







- 1. Dimensions are in millimeters.
- 2. Interpret dimensions and tolerances per ASME Y14.5M-1994.
- 3. Dimension b is measured at the maximum solder ball diameter, parallel to datum plane Z.
- 4. Datum Z (seating plane) is defined by the spherical crowns of the solder balls.
- 5. Parallelism measurement shall exclude any effect of mark on top surface of package.

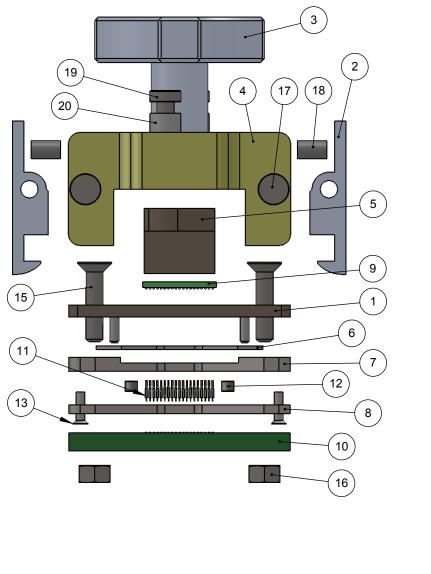
DIM	MIN	MAX
Α		1.25
A1	0.16	0.26
b	0.27	0.37
D	12.95	13.05
E	12.95	13.05
е	.65	
	Array Size	19 X 19
	Pin Count	293

Description: CBT-BGA

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

<u>Tolerances:</u> Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CBT-BGA-7005 Drawing	Material: N/A Finish: N/A Weight: 82.83	STATUS: Released	SHEET: 3 OF 5	REV. B
Ironwood Electronics, Inc. Tele: (800) 404-0204		ENG: M. Tully	DRAWN BY: M. Raske	SCALE: 1:1
www.ironwoodelectronics.com	770igitt. 02.00	FILE: CBT-BGA-7005 Dwg DAT	DATE: 5/23/2014	



PIN	DETAIL

Description: CBT-BGA

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

СВ	T-BGA-7005 Drawing
•	Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com

Material: N/A Finish: N/A Weight: 82.83

STATUS: Released	SHEET: 4 OF 5	REV. B
ENG: M. Tully	DRAWN BY: M. Raske	SCALE: 3:2
FILE: CBT-BGA-7005 Dwg	DATE: 5/23/2014	

ITEM NO.	Description	Material
1	CBT Socket Base 13mm custom foot print	7075-T6 Aluminum Alloy
2	Latch 10-17mm clamshell	7075-T6 Aluminum Alloy
3	M10 Comression Screw	7075-T6 Aluminum Alloy
4	Socket Lid clamshell double latch 17mm	7075-T6 Aluminum Alloy
5	Compression Plate for 13mm IC	7075-T6 Aluminum Alloy
6	CBT-BGA floating guide, 0.65mm Pitch	PEEK Ceramic filled
7	CBT-BGA top guide, 0.65mm Pitch	PEEK Ceramic filled
8	CBT-BGA Bottom guide, 0.65mm Pitch	PEEK Ceramic filled
9	293L LFBGA 13x13mm x 125 thick 0.65mm pitch	Material <not specified=""></not>
10	PCB recomended layout	High Temp FR4
11	SBT Pin, SBT-BGA 0.5mm- 0.8mm	
12	Floating Guide Spring	Alloy Steel (SS)
13	#0-80, 90 deg., head pin guide screw, Peek material 5.5715mm overall Length	PEEK unfilled
14	Dowel Pin, 1/16" x 1/4", SS	Chrome Stainless Steel
15	Flat Head Socket Head Screw M3x0.5, 14mm long	
16	Hex Nut M3 x 0.5mm pitch	Alloy Steel
17	Hinge Pin and Snap Ring, 3mm OD, 25mm long, SS	Stainless Steel (ferritic)
18	Precision Compression Spring, Zinc-Plated Music Wire, 1/2" Length, .12" OD, .016" Wire	Zinc Plated Music Wire
19	Screw, M3 x 12mm, Low Head Cap, SS	18-8 Stainless Steel
20	Spring Clamshell lid assembly	Steel Music Wire

Rev Date		Initials	Description
B 2/11/15 MR Created new BOM, disolver replaced R2885 with R320		MR	Created new BOM, disolved C9797 and C9798, replaced P-P149A with P-P196A, replaced R2885 with R3200

Description: Revision history

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

	CBT-BGA-7005 Drawing	Material: Finish: Weight:	STATUS: Released	SHEET: 5 OF 5	REV. B
	©2015 Ironwood Electronics, Inc. Tele: (800) 404-0204		ENG: M. Tully	DRAWN BY: M. Raske	SCALE: 3:2
TOP	www.ironwoodelectronics.com	wolght.	FILE: CBT-BGA-7005 Dwg	DATE: 5/23/2014	